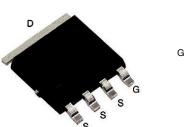


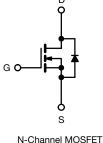


E Series Power MOSFET

PRODUCT SUMMA	RY			
V _{DS} (V) at T _J max.	650)		
R _{DS(on)} typ. at 25 °C (Ω)	V _{GS} = 10 V 0.45			
Q _g max. (nC)	44			
Q _{gs} (nC)	5			
Q _{gd} (nC)	10			
Configuration	Sing	le		

PowerPAK[®] SO-8L Single





FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Qg)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Switch mode power supplies (SMPS)
- Flyback converter
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Consumer
 - Wall adaptors

ORDERING INFORMATION	
Package	PowerPAK SO-8L
Lead (Pb)-free and Halogen-free	SiHJ8N60E-T1-GE3

ABSOLUTE MAXIMUM RATINGS	(T _C = 25 °C, unless otherwis	se noted)			
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage		V _{DS}	600	v	
Gate-Source Voltage	V _{GS}	± 30	v		
Continuous Drain Current (T, = 150 °C)	V_{GS} at 10 V $T_C = 25 \degree C$ $T_C = 100 \degree C$	- I _D	8		
Continuous Drain Current (1) = 150°C)	V_{GS} at 10 V $T_{C} = 100 \text{ °C}$		5	А	
Pulsed Drain Current ^a		I _{DM}	18		
Linear Derating Factor		0.71	W/°C		
Single Pulse Avalanche Energy ^b		E _{AS}	88	mJ	
Maximum Power Dissipation		PD	89	W	
Operating Junction and Storage Temperature I	Range	T _J , T _{stg}	-55 to +150	°C	
Drain-Source Voltage Slope $T_J = 125 \text{ °C}$		dV/dt	70	V/ns	
Reverse Diode dV/dt ^d		uv/di	17	v/ns	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. $V_{DD} = 50$ V, starting $T_J = 25$ °C, L = 28.2 mH, $R_g = 25 \Omega$, $I_{AS} = 2.5$ A

c. $I_{SD} \leq I_D, \, dI/dt$ = 100 A/µs, starting T_J = 25 $^\circ C$

THERMAL RESISTANCE RATI	NGS			
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	52	65	°C/W
Maximum Junction-to-Case (Drain)	R _{thJC}	1	1.4	0/10

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1 For technical questions, contact: <u>hvm@vishay.com</u> Document Number: 91563



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SiHJ8N60E

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PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static		•			•	•		
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	V _{GS} = 0 V, I _D = 250 μA		-	-	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	0.71	-	V/°C	
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA	2	-	4	V	
Cata Cauraa Laakara		\	$V_{\rm GS}$ = ± 20 V	-	-	± 100	nA	
Gate-Source Leakage	I _{GSS}	\	V _{GS} = ± 30 V	-	-	± 1	μA	
Zara Cata Valtaga Drain Current	1	$V_{DS} = 600 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	-	1	V V/°C V nA	μA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 480 V	', V _{GS} = 0 V, T _J = 125 °C	-	-	10		
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 V$	$I_D = 4 A$	-	0.45	0.52	Ω	
Forward Transconductance	g fs	V _{DS}	= 30 V, I _D = 4 A	-	2.4	-	S	
Dynamic								
Input Capacitance	C _{iss}	V _{GS} = 0 V,		-	754	-		
Output Capacitance	C _{oss}	· ·	$V_{DS} = 100 V,$		46	-		
Reverse Transfer Capacitance	C _{rss}		f = 1 MHz	-	5	-		
Effective Output Capacitance, Energy Related ^a	C _{o(er)}			-	40	-	pF	
Effective Output Capacitance, Time Related ^b	C _{o(tr)}	$v_{\rm DS} = 0.0$	/ to 480 V, V_{GS} = 0 V	-	130	-		
Total Gate Charge	Qg			-	22	44		
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 V$	$I_D = 4 \text{ A}, V_{DS} = 480 \text{ V}$	-	5	-	nC	
Gate-Drain Charge	Q _{gd}			-	10	-		
Turn-On Delay Time	t _{d(on)}			-	14	28		
Rise Time	t _r	$V_{\text{DD}} = 480 \text{ V}, \text{ I}_{\text{D}} = 4 \text{ A}, \\ \text{V}_{\text{GS}} = 10 \text{ V}, \text{ R}_{\text{g}} = 9.1 \Omega$		-	15	30		
Turn-Off Delay Time	t _{d(off)}			-	29	58	- 115	
Fall Time	t _f			-	14	28		
Gate Input Resistance	Rg	f = 1 MHz		0.5	0.93	2	Ω	
Drain-Source Body Diode Characteristic	S							
Continuous Source-Drain Diode Current	I _S	MOSFET sym showing the		-	-	8		
Pulsed Diode Forward Current	I _{SM}	integral revers p - n junction		-	-	18		
Diode Forward Voltage	V _{SD}	T _J = 25 °(C, I _S = 4 A, V _{GS} = 0 V	-	0.85	1.2	V	
Reverse Recovery Time	t _{rr}			-	258	516	ns	
Reverse Recovery Charge	Q _{rr}	$T_J = 25 \text{ °C}, I_F = I_{S = 4 \text{ A}},$ di/dt = 100 A/µs ^{, V} _B = 25 V		-	2.4	4.8	μC	
Reverse Recovery Current	I _{BBM}	ai/dt =	100 Α/μs [,] * _R = 25 V	_	16	-	A	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

2



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

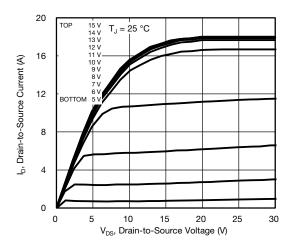
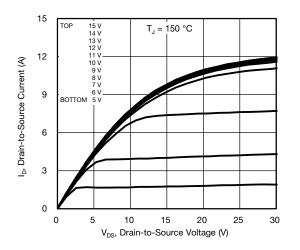
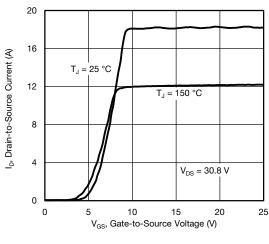
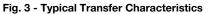


Fig. 1 - Typical Output Characteristics









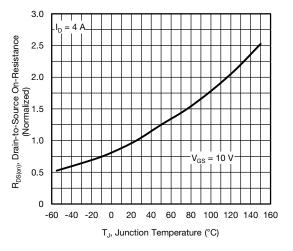


Fig. 4 - Normalized On-Resistance vs. Temperature

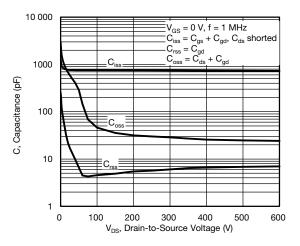


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

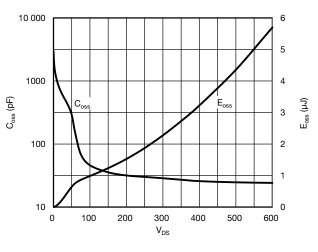


Fig. 6 - $C_{\rm oss}$ and $E_{\rm oss}$ vs. $V_{\rm DS}$

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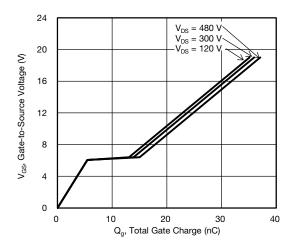


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

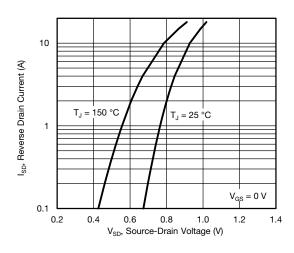


Fig. 8 - Typical Source-Drain Diode Forward Voltage

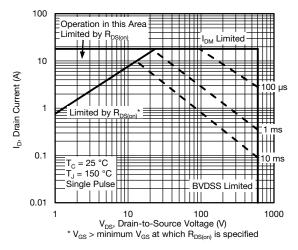


Fig. 9 - Maximum Safe Operating Area

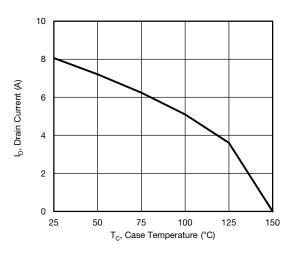


Fig. 10 - Maximum Drain Current vs. Case Temperature

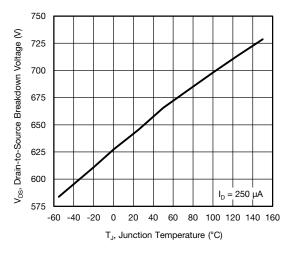
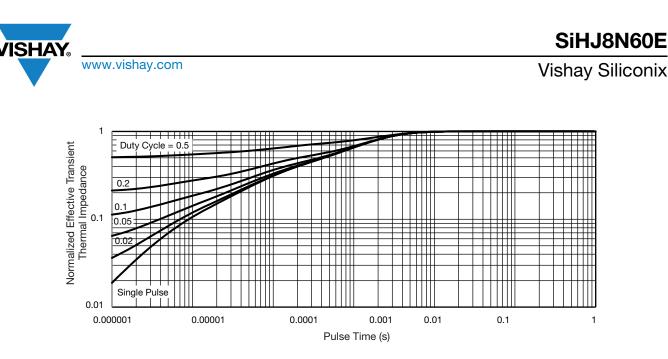


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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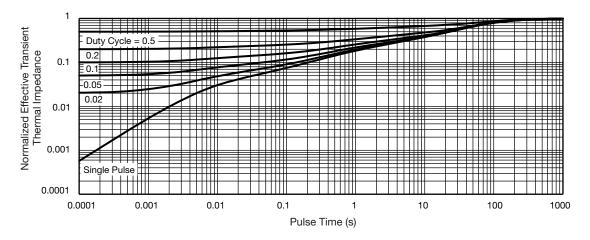


Fig. 13 - Normalized Thermal Transient Impedance, Junction-to-Ambient

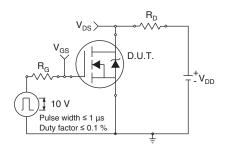


Fig. 14 - Switching Time Test Circuit

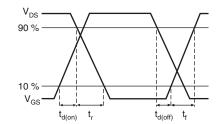


Fig. 15 - Switching Time Waveforms

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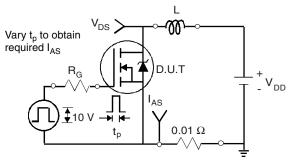


Fig. 16 - Unclamped Inductive Test Circuit

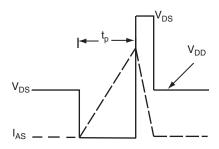


Fig. 17 - Unclamped Inductive Waveforms

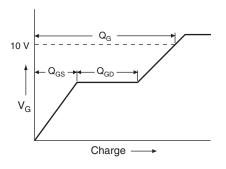


Fig. 18 - Basic Gate Charge Waveform

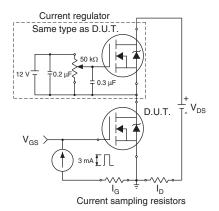
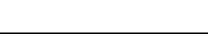


Fig. 19 - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit

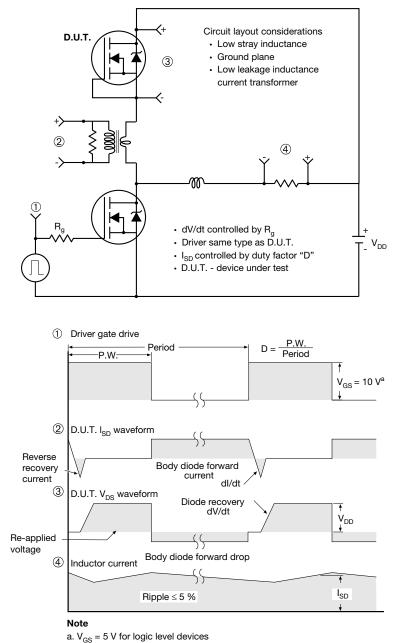


Fig. 20 - For N-Channel

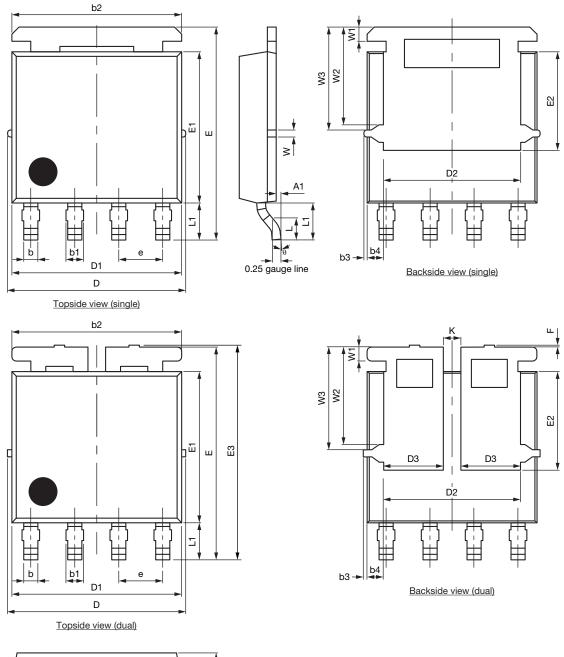
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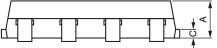
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Package Information



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DIM	MILLIMETERS			INCHES			
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
А	1.00	1.07	1.14	0.039	0.042	0.045	
A1	0.00	-	0.127	0.00	-	0.005	
b	0.33	0.41	0.48	0.013	0.016	0.019	
b1	0.44	0.51	0.58	0.017	0.020	0.023	
b2	4.80	4.90	5.00	0.189	0.193	0.197	
b3		0.094			0.004		
b4		0.47			0.019		
С	0.20	0.25	0.30	0.008	0.010	0.012	
D	5.00	5.13	5.25	0.197	0.202	0.207	
D1	4.80	4.90	5.00	0.189	0.193	0.197	
D2	3.86	3.96	4.06	0.152	0.156	0.160	
D3	1.63	1.73	1.83	0.064	0.068	0.072	
е		1.27 BSC		0.050 BSC			
E	6.05	6.15	6.25	0.238	0.242	0.246	
E1	4.27	4.37	4.47	0.168	0.172	0.176	
E2	2.75	2.85	2.95	0.108	0.112	0.116	
E3	6.05	6.22	6.40	0.238	0.245	0.252	
F	-	-	0.15	-	-	0.006	
L	0.62	0.72	0.82	0.024	0.028	0.032	
L1	0.92	1.07	1.22	0.036	0.042	0.048	
К		0.51		0.020			
W		0.23			0.009		
W1	0.41			0.016			
W2	2.82			0.111			
W3		2.96			0.117		
θ	0°	-	10°	0°	-	10°	

Note

• Millimeters will govern



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RECOMMENDED MINIMUM PAD FOR PowerPAK[®] SO-8L SINGLE



Recommended Minimum Pads Dimensions in mm (inches)

Revision: 07-Feb-12



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